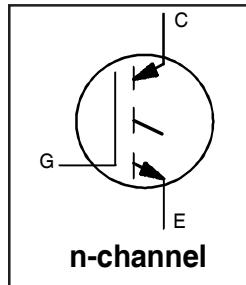


Features

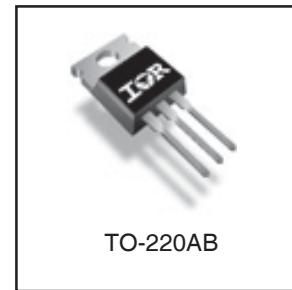
- Standard: optimized for minimum saturation voltage and low operating frequencies ($< 1\text{kHz}$)
- Generation 4 IGBT design provides tighter parameter distribution and higher efficiency than Generation 3
- Industry standard TO-220AB package
- Lead-Free



$V_{CES} = 600\text{V}$
 $V_{CE(on)} \text{ typ.} = 1.32\text{V}$
 $@V_{GE} = 15\text{V}, I_C = 31\text{A}$

Benefits

- Generation 4 IGBTs offer highest efficiency available
- IGBTs optimized for specified application conditions
- Designed to be a "drop-in" replacement for equivalent industry-standard Generation 3 IR IGBTs



Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Breakdown Voltage	600	V
$I_C @ T_C = 25^\circ\text{C}$	Continuous Collector Current	60	A
$I_C @ T_C = 100^\circ\text{C}$	Continuous Collector Current	30	
I_{CM}	Pulsed Collector Current ①	120	
I_{LM}	Clamped Inductive Load Current ②	120	
V_{GE}	Gate-to-Emitter Voltage	± 20	V
E_{ARV}	Reverse Voltage Avalanche Energy ③	15	mJ
$P_D @ T_C = 25^\circ\text{C}$	Maximum Power Dissipation	160	W
$P_D @ T_C = 100^\circ\text{C}$	Maximum Power Dissipation	65	
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to + 150	
	Soldering Temperature, for 10 seconds	300 (0.063 in. (1.6mm from case))	°C
	Mounting torque, 6-32 or M3 screw.	10 lbf•in (1.1N•m)	

Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	---	0.77	°C/W
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.50	---	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	---	80	
Wt	Weight	2.0 (0.07)	---	g (oz)

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(BR)CES}$	Collector-to-Emitter Breakdown Voltage	600	—	—	V	$V_{GE} = 0V, I_C = 250\mu\text{A}$
$V_{(BR)ECS}$	Emitter-to-Collector Breakdown Voltage ④	18	—	—	V	$V_{GE} = 0V, I_C = 1.0\text{A}$
$\Delta V_{(BR)CES}/\Delta T_J$	Temperature Coeff. of Breakdown Voltage	—	0.75	—	V/ $^\circ\text{C}$	$V_{GE} = 0V, I_C = 1.0\text{mA}$
$V_{CE(\text{ON})}$	Collector-to-Emitter Saturation Voltage	—	1.32	1.5	V	$I_C = 31\text{A}$
		—	1.68	—		$I_C = 60\text{A}$
		—	1.32	—		$I_C = 31\text{A}, T_J = 150^\circ\text{C}$
$V_{GE(\text{th})}$	Gate Threshold Voltage	3.0	—	6.0		$V_{CE} = V_{GE}, I_C = 250\mu\text{A}$
$\Delta V_{GE(\text{th})}/\Delta T_J$	Temperature Coeff. of Threshold Voltage	—	-9.3	—	mV/ $^\circ\text{C}$	$V_{CE} = V_{GE}, I_C = 250\mu\text{A}$
g_{fe}	Forward Transconductance ⑤	12	21	—	S	$V_{CE} = 100V, I_C = 31\text{A}$
I_{CES}	Zero Gate Voltage Collector Current	—	—	250	μA	$V_{GE} = 0V, V_{CE} = 600V$
		—	—	2.0		$V_{GE} = 0V, V_{CE} = 10V, T_J = 25^\circ\text{C}$
		—	—	1000		$V_{GE} = 0V, V_{CE} = 600V, T_J = 150^\circ\text{C}$
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 100	nA	$V_{GE} = \pm 20V$

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
Q_g	Total Gate Charge (turn-on)	—	100	150	nC	$I_C = 31\text{A}$
Q_{ge}	Gate - Emitter Charge (turn-on)	—	14	21		$V_{CC} = 400V$
Q_{gc}	Gate - Collector Charge (turn-on)	—	34	51		See Fig. 8 $V_{GE} = 15V$
$t_{d(\text{on})}$	Turn-On Delay Time	—	22	—	ns	$T_J = 25^\circ\text{C}$ $I_C = 31\text{A}, V_{CC} = 480V$ $V_{GE} = 15V, R_G = 10\Omega$
t_r	Rise Time	—	18	—		
$t_{d(\text{off})}$	Turn-Off Delay Time	—	650	980		
t_f	Fall Time	—	380	570		
E_{on}	Turn-On Switching Loss	—	0.45	—	mJ	Energy losses include "tail" See Fig. 10, 11, 13, 14
E_{off}	Turn-Off Switching Loss	—	6.5	—		
E_{ts}	Total Switching Loss	—	6.95	9.9		
$t_{d(\text{on})}$	Turn-On Delay Time	—	23	—	ns	$T_J = 150^\circ\text{C}$, $I_C = 31\text{A}, V_{CC} = 480V$ $V_{GE} = 15V, R_G = 10\Omega$
t_r	Rise Time	—	21	—		
$t_{d(\text{off})}$	Turn-Off Delay Time	—	1000	—		
t_f	Fall Time	—	940	—		
E_{ts}	Total Switching Loss	—	12	—	mJ	Energy losses include "tail" See Fig. 13, 14
L_E	Internal Emitter Inductance	—	7.5	—	nH	Measured 5mm from package
C_{ies}	Input Capacitance	—	2200	—	pF	$V_{GE} = 0V$ $V_{CC} = 30V$
C_{oes}	Output Capacitance	—	140	—		
C_{res}	Reverse Transfer Capacitance	—	26	—		See Fig. 7 $f = 1.0\text{MHz}$

Notes:

- ① Repetitive rating; $V_{GE} = 20V$, pulse width limited by max. junction temperature. (See fig. 13b)
- ④ Pulse width $\leq 80\mu\text{s}$; duty factor $\leq 0.1\%$.
- ② $V_{CC} = 80\%(V_{CES})$, $V_{GE} = 20V$, $L = 10\mu\text{H}$, $R_G = 10\Omega$, (See fig. 13a)
- ⑤ Pulse width $5.0\mu\text{s}$, single shot.
- ③ Repetitive rating; pulse width limited by maximum junction temperature.

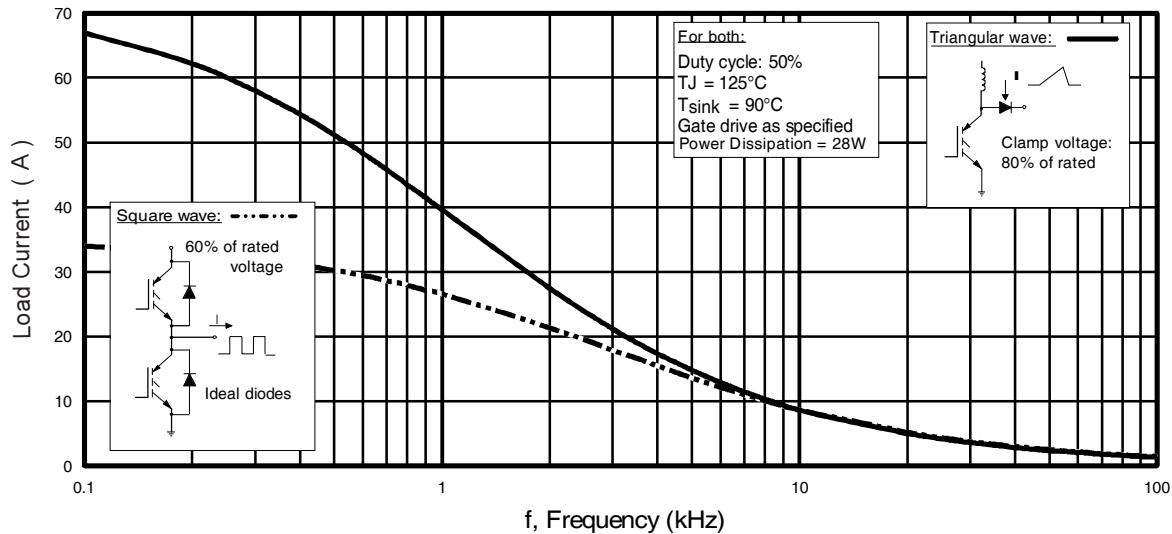


Fig. 1 - Typical Load Current vs. Frequency
 (For square wave, $I=I_{RMS}$ of fundamental; for triangular wave, $I=I_{PK}$)

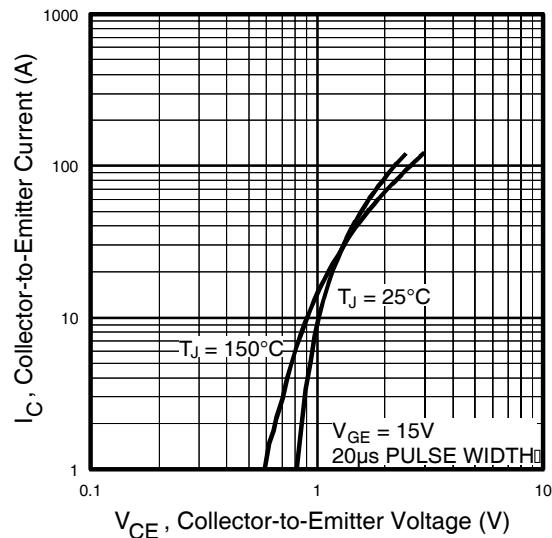


Fig. 2 - Typical Output Characteristics

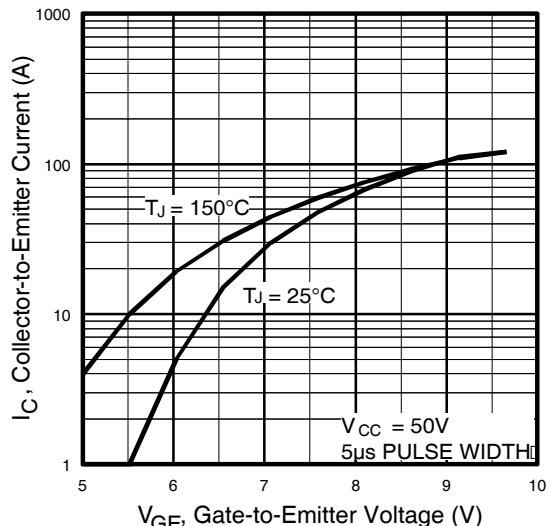


Fig. 3 - Typical Transfer Characteristics

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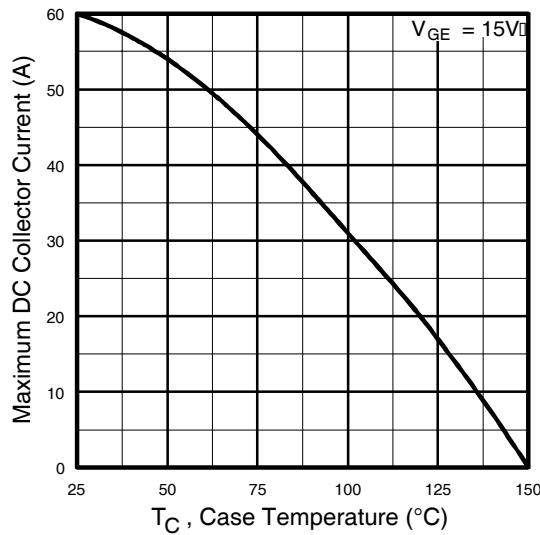


Fig. 4 - Maximum Collector Current vs. Case Temperature

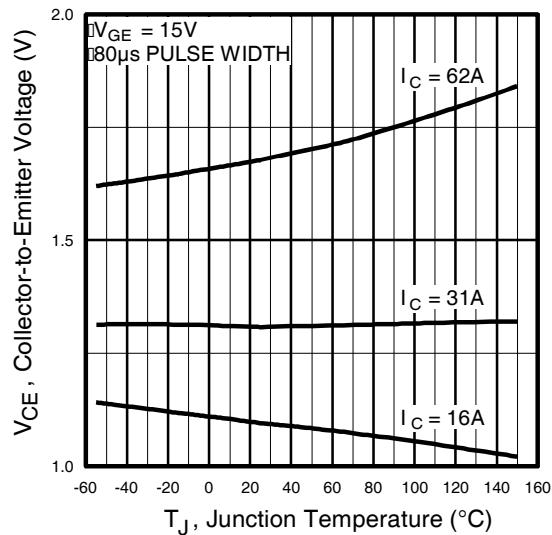


Fig. 5 - Collector-to-Emitter Voltage vs. Junction Temperature

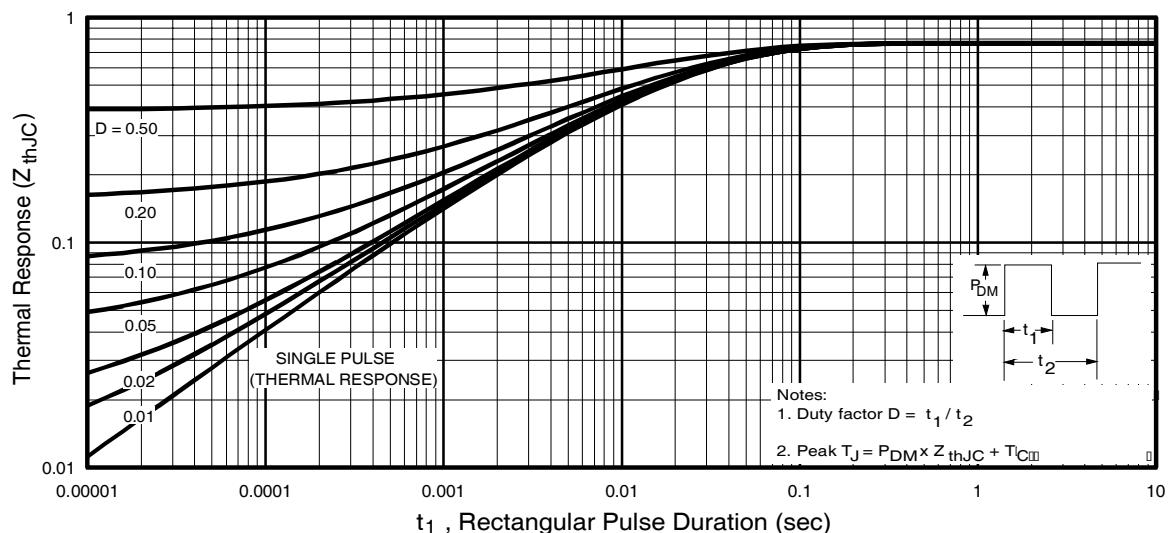


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

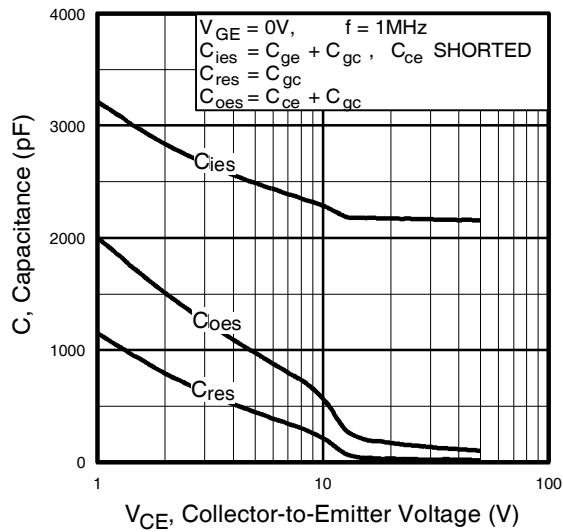


Fig. 7 - Typical Capacitance vs.
 Collector-to-Emitter Voltage

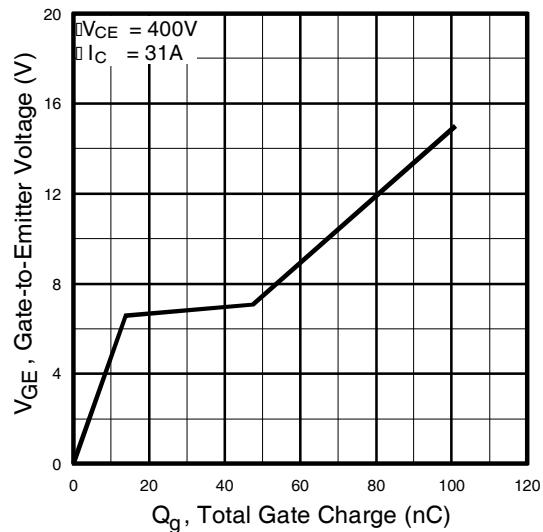


Fig. 8 - Typical Gate Charge vs.
 Gate-to-Emitter Voltage

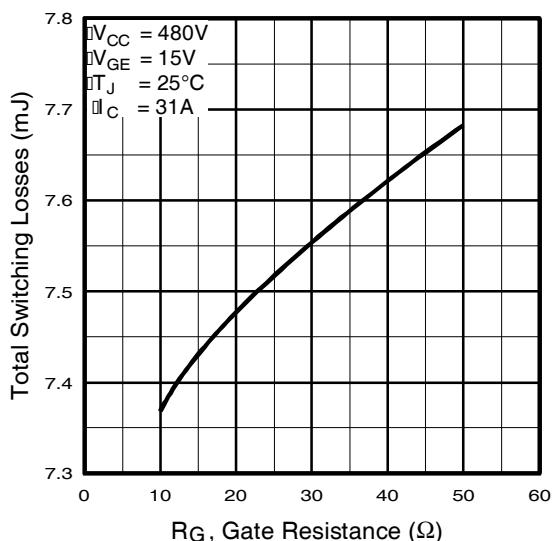


Fig. 9 - Typical Switching Losses vs. Gate
 Resistance

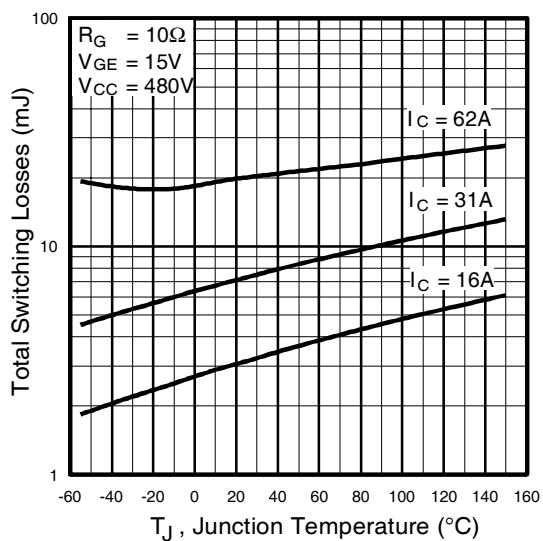


Fig. 10 - Typical Switching Losses vs.
 Junction Temperature

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IR Rectifier

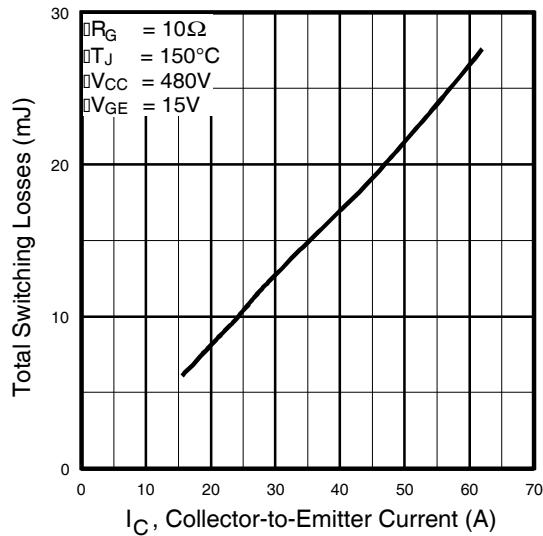


Fig. 11 - Typical Switching Losses vs.
Collector-to-Emitter Current

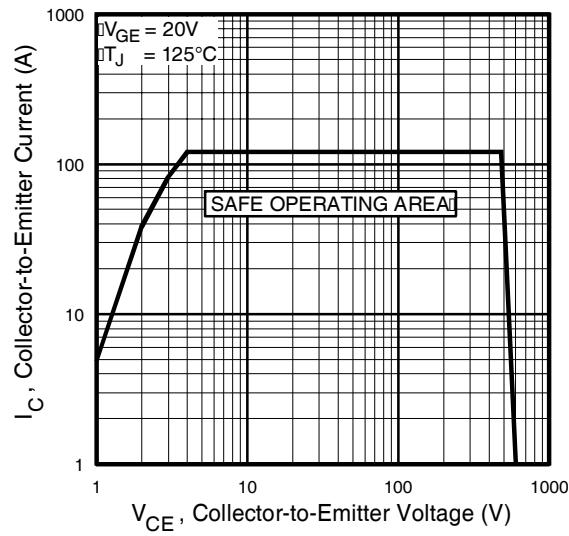
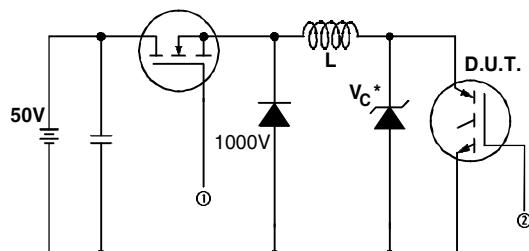
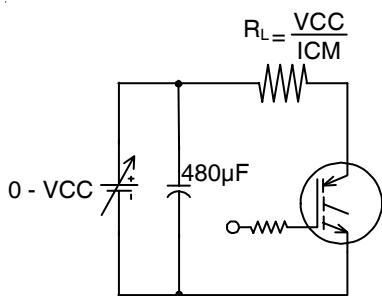


Fig. 12 - Turn-Off SOA



* Driver same type as D.U.T.; $V_c = 80\%$ of $V_{ce(max)}$
 * Note: Due to the 50V power supply, pulse width and inductor will increase to obtain rated I_d .

Fig. 13a - Clamped Inductive Load Test Circuit



Pulsed Collector Current Test Circuit

Fig. 13b - Pulsed Collector Current Test Circuit

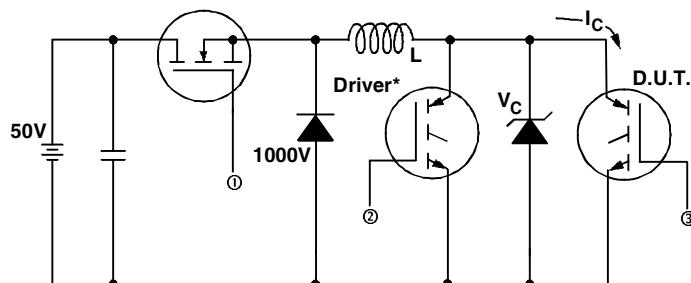


Fig. 14a - Switching Loss Test Circuit

* Driver same type as D.U.T., $V_C = 480V$

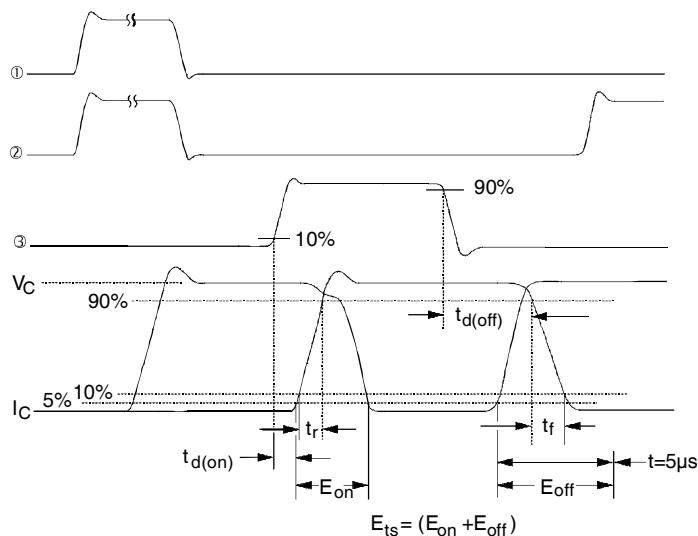
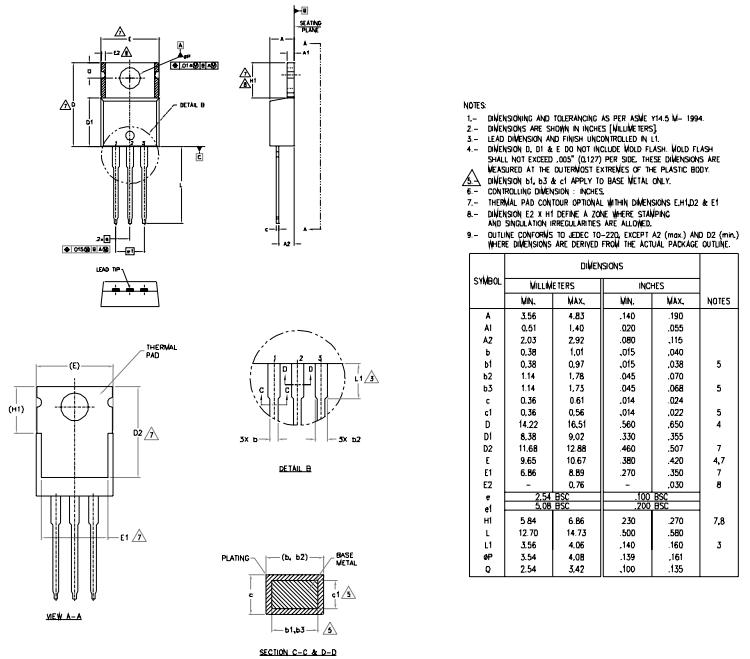


Fig. 14b - Switching Loss Waveforms

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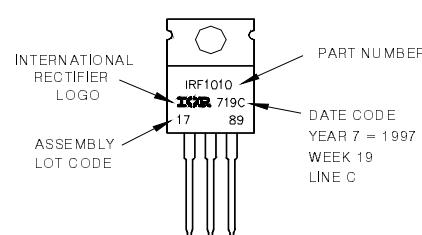
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TO-220AB Package Outline (Dimensions are shown in millimeters (inches))



TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010
LOT CODE 1789
ASSEMBLED ON WW 19, 1997
IN THE ASSEMBLY LINE 'C'
Note: "P" in assembly line
position indicates "Lead-Free"



Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

Data and specifications subject to change without notice.

International
IR Rectifier

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